

APR 24 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 3679
Examiner: Bochna, David

In Re PATENT APPLICATION Of:

Applicant(s) : Hui-Chun Hsu)
Applic. No. : 10/770,473)
Filed : Feb. 4, 2004)
For : Shrinkage-Free Sealing Structure of Heat Pipe)
Attorney Ref.: OP-092000372)

AMENDMENT

April 24, 2006

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Responsive to the Examiner's Action dated January 24, 2006, please amend the above-identified application as follows.

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